FAIRCHILD

SEMICONDUCTOR™

100325

Low Power Hex ECL-to-TTL Translator

General Description

The 100325 is a hex translator for converting F100K logic levels to TTL logic levels. Differential inputs allow each circuit to be used as an inverting, non-inverting or differential receiver. An internal reference voltage generator provides V_{BB} for single-ended operation, or for use in Schmitt trigger applications. All inputs have 50kΩ pull-down resistors. When the inputs are either unconnected or at the same potential the outputs will go LOW.

When used in single-ended operation the apparent input threshold of the true inputs is 20mV to 40mV higher (positive) than the threshold of the complementary inputs. The V_{EE} and V_{TTL} power may be applied in either order.

Features

■ Pin/function compatible with 100125
■ Meets 100125 AC specifications
■ 50% power reduction of the 100125
■ Differential inputs with built in offset
■ Standard FAST® outputs
■ 2000V ESD protection
■ −4.2V to −5.7V operating range
■ Available to industrial grade temperature range

Ordering Code:

| Order Number	Package Number	Package Description
100325SC	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
100325PC	N24E	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide
100325QI	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
100325QC	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Industrial Temperature Range (−40°C to +85°C)

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagrams

24-Pin DIP/SOIC
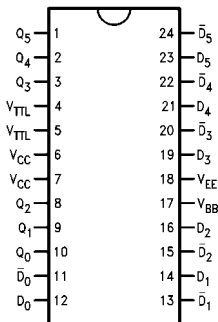
28-Pin PLCC
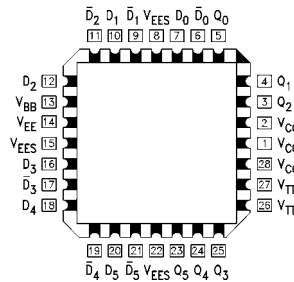
Pin Descriptions

Pin Names	Description
D_0–D_5	Data Inputs
$\overline{D}_0$–$\overline{D}_5$	Inverting Data Inputs
Q_0–Q_5	Data Outputs

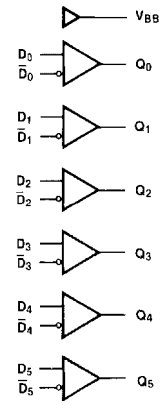FAST® is a registered trademark of Fairchild Semiconductor Corporation.

100325

Truth Table

Inputs		Outputs
D_n	$\overline{D}_n$	Q_n
L	H	L
H	L	H
L	L	L
H	H	L
OPEN	OPEN	L
V_{EE}	V_{EE}	L
L	V_{BB}	L
H	V_{BB}	H
V_{BB}	L	H
V_{BB}	H	L

H = HIGH Voltage Level
L = LOW Voltage Level

Logic Diagram

V_{BB}

D_0 $\overline{D}_0$ → Q_0

D_1 $\overline{D}_1$ → Q_1

D_2 $\overline{D}_2$ → Q_2

D_3 $\overline{D}_3$ → Q_3

D_4 $\overline{D}_4$ → Q_4

D_5 $\overline{D}_5$ → Q_5

Absolute Maximum Ratings(Note 1)

Storage Temperature (T$_{STG}$)	−65°C to +150°C
Maximum Junction Temperature (T$_J$)	+150°C
V$_{EE}$ Pin Potential to Ground Pin	−7.0V to +0.5V
V$_{TTL}$ Pin Potential to Ground Pin	−0.5V to +6.0V
Input Voltage (DC)	V$_{EE}$ to +0.5V
Voltage Applied to Output	
in HIGH State (with V$_{CC}$ = 0V)	−0.5V to V$_{CC}$
Current Applied to Output	
in LOW State (Max)	twice the rated I$_{OL}$ (mA)
ESD (Note 2)	≥2000V

Recommended Operating Conditions

Case Temperature (T$_C$)	
Commercial	0°C to +85°C
Industrial	−40°C to +85°C
Supply Voltage (V$_{EE}$)	−5.7V to −4.2V

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Commercial Version

DC Electrical Characteristics

V$_{EE}$ = −4.2V to −5.7V, V$_{CC}$ = GND, V$_{TTL}$ = +4.5V to 5.5V, T$_C$ = 0°C to +85°C (Note 3)

Symbol	Parameter	Min	Typ	Max	Units	Conditions	
V$_{BB}$	Output Reference Voltage	−1380	−1320	−1260	mV	I$_{VBB}$ = −2.1 mA	
V$_{IH}$	Single-Ended Input HIGH Voltage	−1165		−870	mV	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V$_{BB}$)	
V$_{IL}$	Single-Ended Input LOW Voltage	−1830		−1475	mV	Guaranteed LOW Signal for All Inputs (with One Input Tied to V$_{BB}$)	
V$_{OH}$	Output HIGH Voltage	2.5			V	I$_{OH}$ = −2.0 mA	V$_{IN}$ = V$_{IH\ (Max)}$
V$_{OL}$	Output LOW Voltage			0.5	V	I$_{OL}$ = 20 mA	or V$_{IL\ (Min)}$
V$_{DIFF}$	Input Voltage Differential	150			mV	Required for Full Output Swing	
V$_{CM}$	Common Mode Voltage	V$_{CC}$ − 2.0		V$_{CC}$ − 0.5	V		
I$_{IH}$	Input HIGH Current			350	µA	V$_{IN}$ = V$_{IH\ (Max)}$, D$_0$–D$_5$ = V$_{BB}$, $\overline{D}_0$–$\overline{D}_5$ = V$_{IL\ (Min)}$	
I$_{IL}$	Input LOW Current	0.5			µA	V$_{IN}$ = V$_{IL\ (Min)}$, D$_0$–D$_5$ = V$_{BB}$	
I$_{OS}$	Output Short-Circuit Current	−150		−60	mA	V$_{OUT}$ = GND (Note 4)	
I$_{EE}$	V$_{EE}$ Power Supply Current	−37	−27	−17	mA	D$_0$–D$_5$ = V$_{BB}$	
I$_{TTL}$	V$_{TTL}$ Power Supply Current		45	65	mA	D$_0$–D$_5$ = V$_{BB}$	

Note 3: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

Note 4: Test one output at a time.

DIP AC Electrical Characteristics

V$_{EE}$ = −4.2V to −5.7V, V$_{CC}$ = GND, V$_{TTL}$ = +4.5V to +5.5V

Symbol	Parameter	T$_C$ = 0°C		T$_C$ = +25°C		T$_C$ = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t$_{PLH}$ t$_{PHL}$	Propagation Delay Data to Output	0.80	3.50	0.90	3.70	1.00	4.00	ns	C$_L$ = 15 pF Figures 1, 2
t$_{PLH}$ t$_{PHL}$	Propagation Delay Data to Output	1.60	4.30	1.70	4.50	1.80	4.80	ns	C$_L$ = 50 pF Figures 1, 3

Commercial Version (Continued)
SOIC and PLCC AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = GND, V_{TTL} = +4.5V to +5.5V

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.80	3.30	0.90	3.50	1.00	3.80	ns	C_L = 15 pF Figures 1, 2
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.60	4.10	1.70	4.30	1.80	4.60	ns	C_L = 50 pF Figures 1, 3
t_{OSHL}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		0.65		0.65		0.65	ns	PLCC Only (Note 5)
t_{OSLH}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		0.65		0.65		0.65	ns	PLCC Only (Note 5)
t_{OST}	Maximum Skew Opposite Edge Output-to-Output Variation Data to Output Path		2.20		2.20		2.20	ns	PLCC Only (Note 5)
t_{PS}	Maximum Skew Pin (Signal) Transition Variation Data to Output Path		2.10		2.10		2.10	ns	PLCC Only (Note 5)

Note 5: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}), or LOW-to-HIGH (t_{OSLH}), or in opposite directions both HL and LH (t_{OST}). Parameters t_{OST} and t_{PS} guaranteed by design.

Industrial Version

PLCC DC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = GND$, $T_C = -40°C$ to $+85°C$ (Note 6)

Symbol	Parameter	$T_C = -40°C$		$T_C = 0°C$ to $+85°C$		Units	Conditions	
		Min	Max	Min	Max			
V_{BB}	Output Reference Voltage	−1395	−1255	−1380	−1260	mV	$I_{VBB} = -2.1$ mA	
V_{IH}	Single-Ended Input HIGH Voltage	−1170	−870	−1165	−870	mV	Guaranteed HIGH Signal for All Inputs (with One Input Tied to V_{BB})	
V_{IL}	Single-Ended Input LOW Voltage	−1830	−1480	−1830	−1475	mV	Guaranteed LOW Signal for All Inputs (with One Input Tied to V_{BB})	
V_{OH}	Output HIGH Voltage	2.5		2.5		V	$I_{OH} = -2.0$ mA	$V_{IN} = V_{IH\,(Max)}$
V_{OL}	Output LOW Voltage		0.5		0.5	V	$I_{OL} = 20$ mA	or $V_{IL\,(Min)}$
V_{DIFF}	Input Voltage Differential	150		150		mV	Required for Full Output Swing	
V_{CM}	Common Mode Voltage	$V_{CC} - 2.0$	$V_{CC} - 0.5$	$V_{CC} - 2.0$	$V_{CC} - 0.5$	V		
I_{IH}	Input HIGH Current		450		350	µA	$V_{IN} = V_{IH\,(Max)}$, $D_0–D_5 = V_{BB}$, $\overline{D}_0–\overline{D}_5 = V_{IL\,(Min)}$	
I_{IL}	Input LOW Current	0.5		0.5		µA	$V_{IN} = V_{IL\,(Min)}$, $D_0–D_5 = V_{BB}$	
I_{OS}	Output Short-Circuit Current	−150	−60	−150	−60	mA	$V_{OUT} = GND$ (Note 7)	
I_{EE}	V_{EE} Power Supply Current	−37	−15	−37	−17	mA	$D_0–D_5 = V_{BB}$	
I_{TTL}	V_{TTL} Power Supply Current		65		65	mA	$D_0–D_5 = V_{BB}$	

Note 6: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

Note 7: Test one output at a time.

PLCC AC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = GND$, $V_{TTL} = +4.5V$ to $+5.5V$

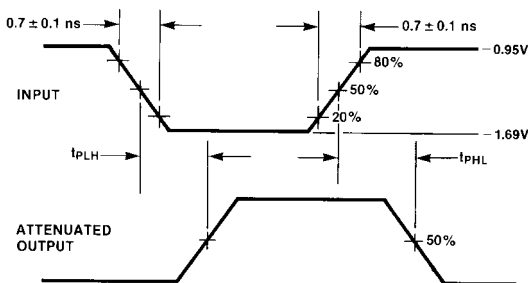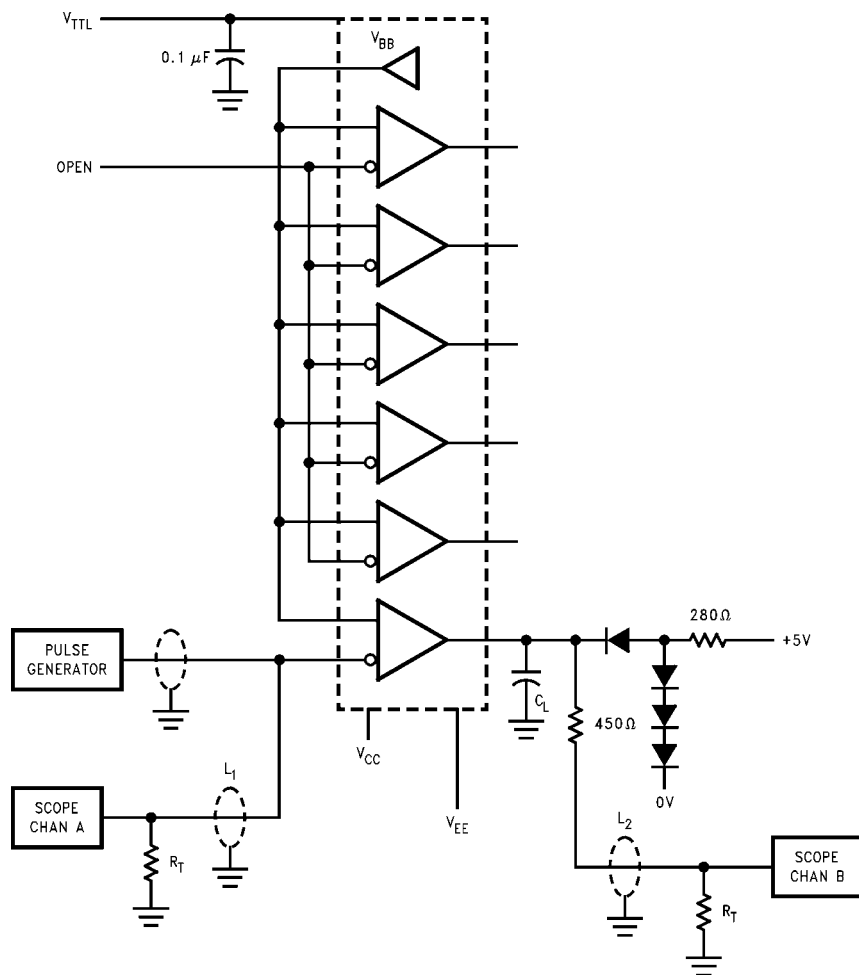| Symbol	Parameter	$T_C = -40°C$		$T_C = +25°C$		$T_C = +85°C$		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.80	3.30	0.90	3.50	1.00	3.80	ns	$C_L = 15$ pF Figures 1, 2
t_{PLH} t_{PHL}	Propagation Delay Data to Output	1.60	4.10	1.70	4.30	1.80	4.60	ns	$C_L = 50$ pF Figures 1, 3

Switching Waveform

FIGURE 1. Propagation Delay
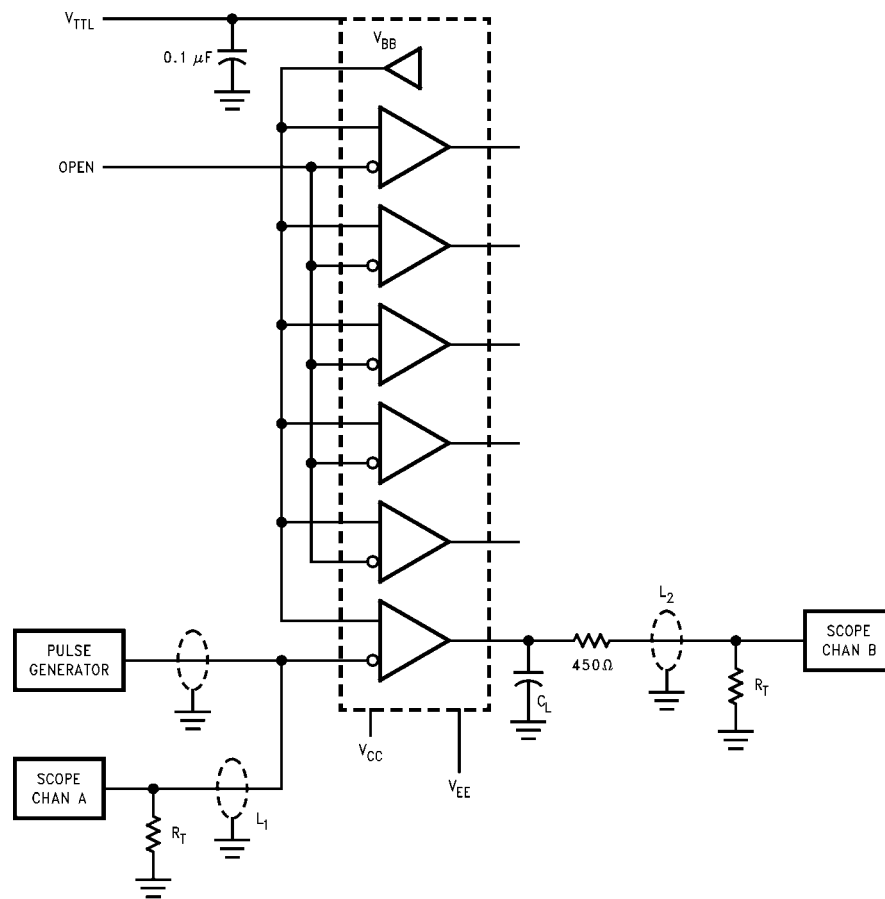
Test Circuits

Note:

- V_{CC} = 0V, V_{EE} = −4.5V, V_{TTL} = +5V
- L1 and L2 = equal length 50Ω impedance lines
- R_T = 50Ω terminator internal to scope
- Decoupling 0.1 μF from GND to V_{CC}, V_{EE} and V_{TTL}
- All unused outputs are loaded with 500Ω to GND
- C_L = Fixture and stray capacitance = 15 pF

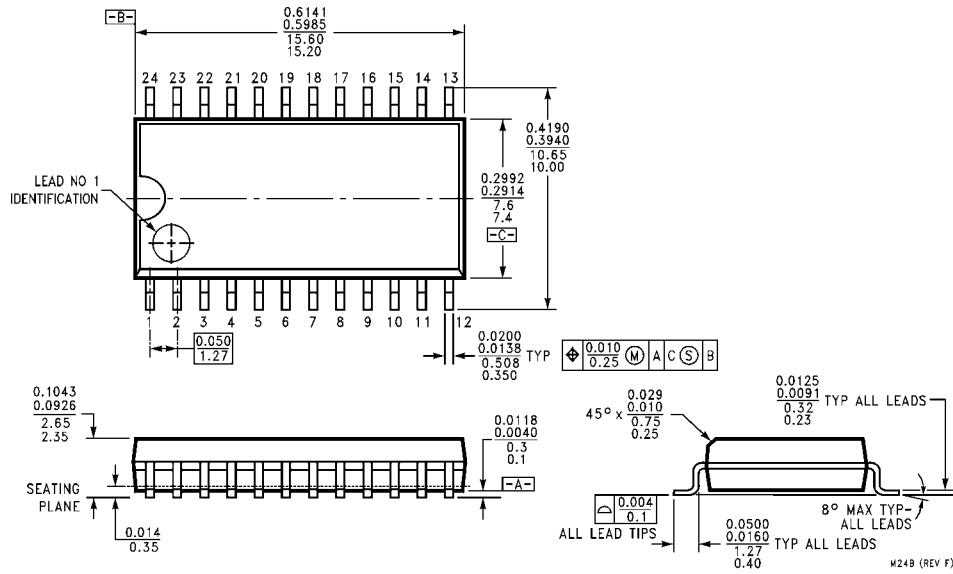**FIGURE 2. AC Test Circuit for 15 pF Loading**
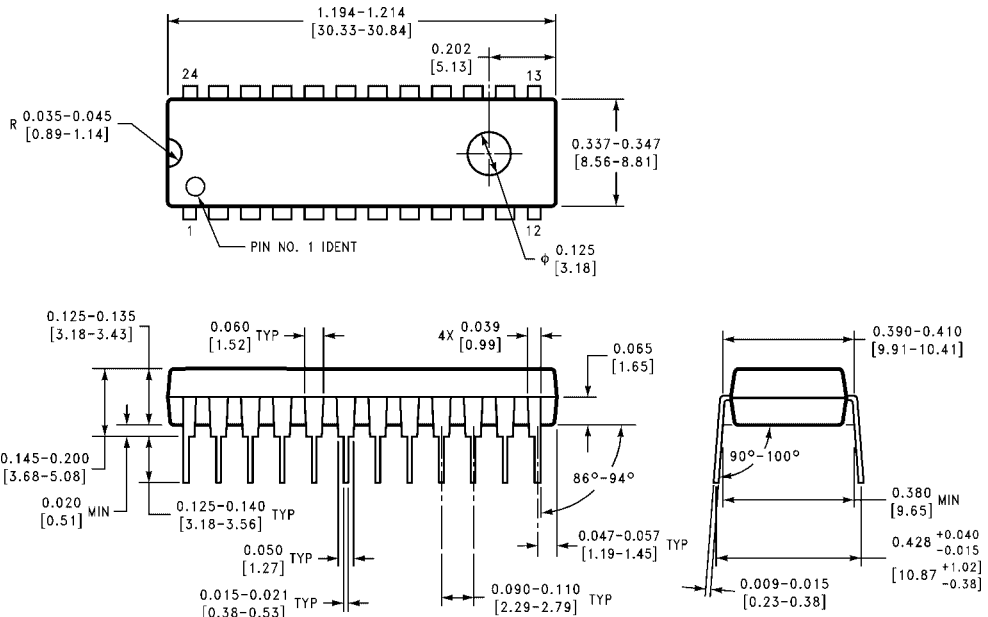
Test Circuits (Continued)

Note:

- $V_{CC} = 0V$, $V_{EE} = -4.5V$, $V_{TTL} = +5V$
- L1 and L2 = equal length 50Ω impedance lines
- R_T = 50Ω terminator internal to scope
- Decoupling 0.1 µF from GND to V_{CC}, V_{EE} and V_{TTL}
- All unused outputs are loaded with 500Ω to GND
- C_L = Fixture and stray capacitance = 50 pF

FIGURE 3. AC Test Circuit for 50 pF Loading

## Physical Dimensions inches (millimeters) unless otherwise noted

-B-

0.6141
0.5985
15.60
15.20

24 23 22 21 20 19 18 17 16 15 14 13

LEAD NO 1
IDENTIFICATION

0.4190
0.3940
10.65
10.00

0.2992
0.2914
7.6
7.4
-C-

1 2 3 4 5 6 7 8 9 10 11 12

0.050
1.27

0.0200
0.0138
0.508 TYP
0.350

⌖ 0.010 Ⓜ A C Ⓢ B
0.25

0.1043
0.0926
2.65
2.35

0.0118
0.0040
0.3
0.1

-A-

SEATING
PLANE

0.014
0.35

45° X 0.029
0.010
0.75
0.25

0.0125
0.0091 TYP ALL LEADS
0.32
0.23

⌒ 0.004
0.1
ALL LEAD TIPS

0.0500
0.0160 TYP ALL LEADS
1.27
0.40

8° MAX TYP-
ALL LEADS

M24B (REV F)

24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M24B

1.194−1.214
[30.33−30.84]

0.202
[5.13]

24   13

R 0.035−0.045
[0.89−1.14]

0.337−0.347
[8.56−8.81]

1   12

PIN NO. 1 IDENT

φ 0.125
[3.18]

0.125−0.135
[3.18−3.43]

0.060 TYP
[1.52]

4X 0.039
[0.99]

0.065
[1.65]

0.390−0.410
[9.91−10.41]

0.145−0.200
[3.68−5.08]

0.020 MIN
[0.51]

0.125−0.140 TYP
[3.18−3.56]

0.050 TYP
[1.27]

0.015−0.021 TYP
[0.38−0.53]

0.090−0.110 TYP
[2.29−2.79]

86°−94°

0.047−0.057 TYP
[1.19−1.45]

90°−100°

0.380 MIN
[9.65]

0.428 +0.040
−0.015
[10.87 +1.02
−0.38]

0.009−0.015
[0.23−0.38]

N24E (REV A)

24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide
Package Number N24E

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)
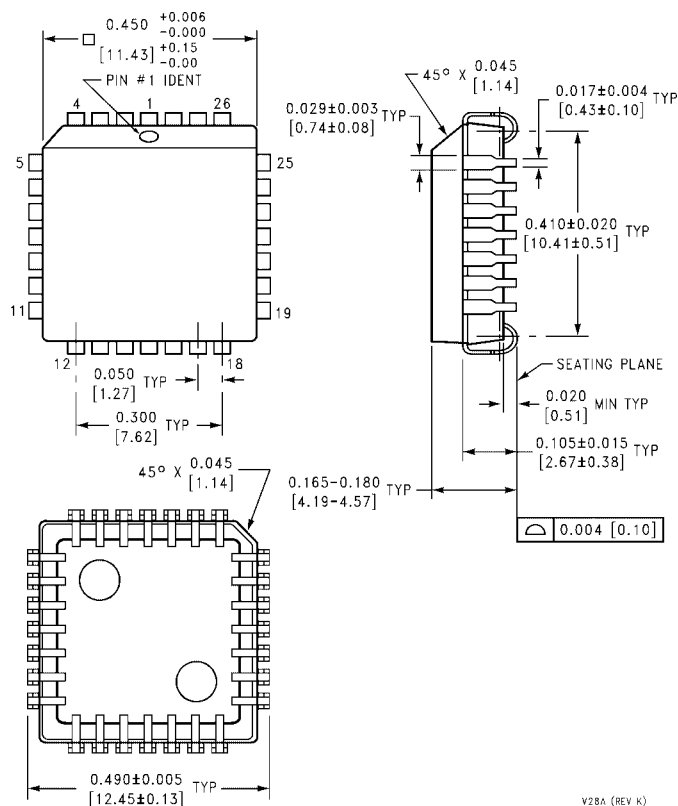
28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
Package Number V28A

LIFE SUPPORT POLICY

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